

Bipolar Transistors Silicon PNP Epitaxial Type

TTA502

1. Applications

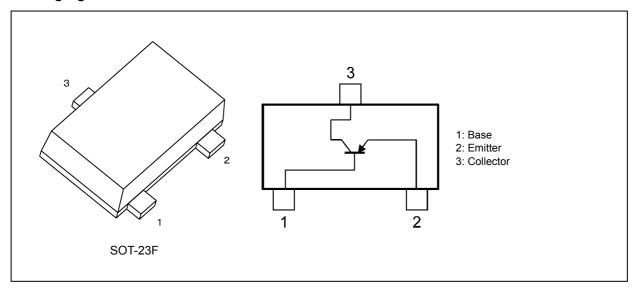
- · High-Speed Switching
- · DC-DC Converters

2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) High DC current gain: $h_{\rm FE}$ = 200 to 500 ($I_{\rm C}$ = -0.5 A)
- (3) Low collector-emitter saturation voltage: $V_{CE(sat)} = -0.19 \text{ V (max)}$
- (4) High-speed switching: $t_f = 40 \text{ ns (typ.)}$

Note 1: For detail information, please contact our sales.

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics			Symbol	Rating	Unit
Collector-base voltage			V_{CBO}	-30	V
Collector-emitter voltage	,		V_{CEO}	-20	V
Emitter-base voltage	,		V _{EBO}	-7	V
Collector current (DC)		(Note 1)	Ic	-2.5	Α
Collector current (pulsed)		(Note 1)	I _{CP}	-4.0	Α
Base current			I _B	-250	mA
Collector power dissipation	DC	(Note 2)	Pc	1	W
Collector power dissipation	(t = 1 s)	(Note 2)	P _C	1.3	W
Junction temperature			Tj	150	°C
Storage temperature			T _{stg}	- 55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Ensure that the channel temperature does not exceed 150 °C.
- Note 2: Device mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm ,Cu pad: 645 mm²)



5. Electrical Characteristics

5.1. Static Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	V_{CB} = -30 V , I_E = 0 mA	_	_	-100	nA
Emitter cut-off current	I _{EBO}	$V_{EB} = -7 \text{ V, } I_{C} = 0 \text{ mA}$	_	_	-100	nA
Collector-emitter breakdown voltage	V _{(BR)CEO}	I_{C} = -10 mA, I_{B} = 0 mA	-20			V
DC current gain	h _{FE} (1)	$V_{CE} = -2 \text{ V}, I_{C} = -0.5 \text{ A}$	200	_	500	_
	h _{FE} (2)	$V_{CE} = -2 \text{ V}, I_{C} = -1.6 \text{ A}$	100	_	_	_
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -1.6 A, I _B = -53 mA	_		-0.19	٧
Base-emitter saturation voltage	V _{BE(sat)}	I _C = -1.6 A, I _B = -53 mA	_		-1.1	V

5.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector output capacitance	C _{ob}	$V_{CB} = -10 \text{ V}, I_{E} = 0 \text{ mA},$ f = 1 MHz	_	28		pF
Switching time (rise time)	t _r	See Figure 5.2.1	_	70	_	ns
Switching time (storage time)	t _{stg}	$V_{cc} \approx -12 \text{ V, R}_{L} = 7.5 \Omega,$ $I_{B1} = 53 \text{ mA, } I_{B2} = 53 \text{ mA}$	_	150		ns
Switching time (fall time)	t _f	181 – 33 IIIA, 182 – 33 IIIA	_	40	_	ns

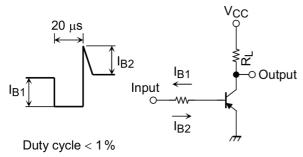
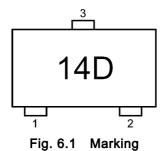


Fig. 5.2.1 Switching Time Test Circuit

6. Marking



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7. Characteristics Curves (Note)

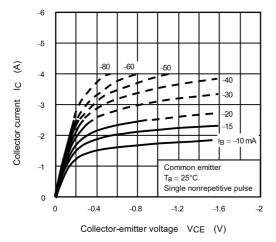


Fig. 7.1 I_C - V_{CE}

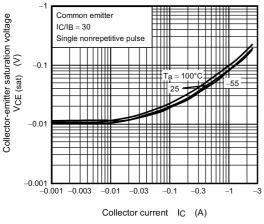


Fig. 7.3 V_{CE(sat)} - I_C

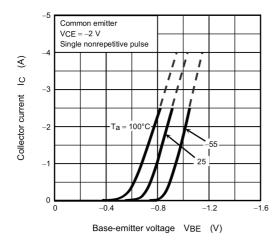


Fig. 7.5 I_C - V_{BE}

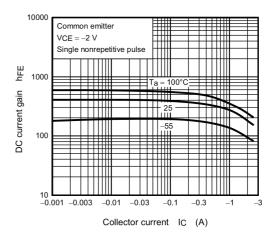


Fig. 7.2 h_{FE} - I_C

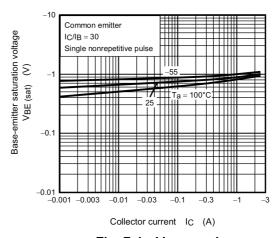


Fig. 7.4 V_{BE(sat)} - I_C



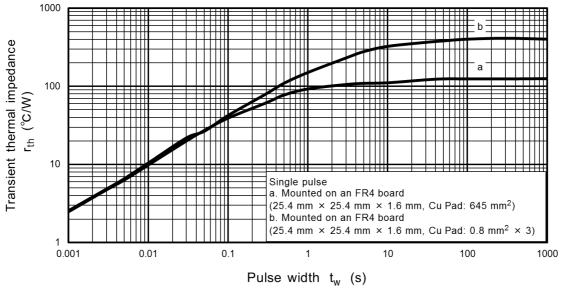


Fig. 7.6 rth - tw

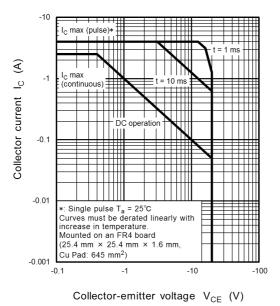


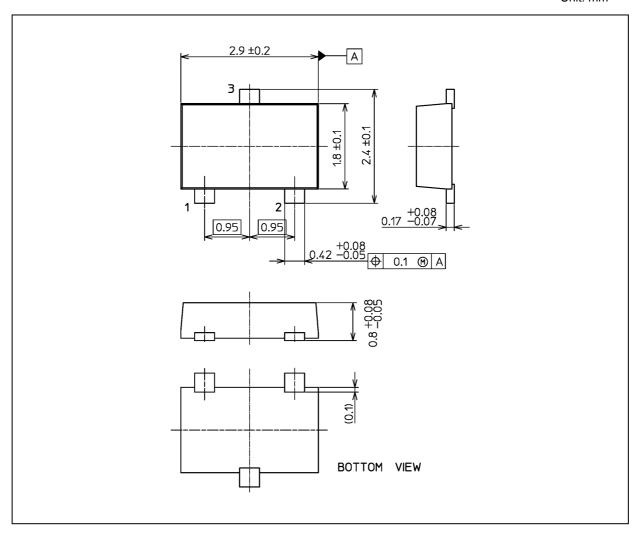
Fig. 7.7 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.011 g (typ.)

	Package Name(s)
Nickname: SOT-23F	



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